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Docket No.: 20099/0200781-US0
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent Application of:
Ken Koyama et al.

Application No.: 10/781,358

Confirmation No.: 9212

Filed: February 17, 2004

Art Unit: 1775

For: Al-Cu BONDED STRUCTURE AND METHOD
FOR MAKING THE SAME

Examiner: J. J. Zimmerman

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated August 11, 2004, please amend the above-identified U.S. patent application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 6 of this paper.